

SOD-123FL Plastic-Encapsulate Diodes

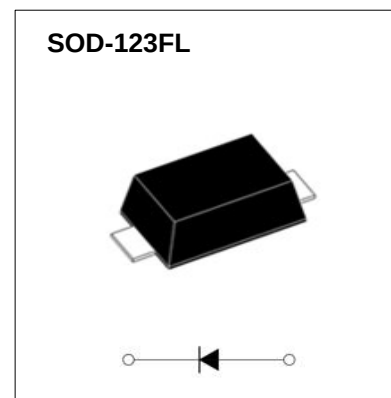
Schottky Rectifier

Features

- I_o 1A
- V_{RRM} 20V-200V
- Low forward voltage drop
- High surge current capability
- Metal silicon junction, majority carrier conduction

Mechical Data

- Case: SOD-123FL molded plastic
- Molding compound: UL flammability classification rating 94V-0
- Terminals: Solder plated, solderable per MIL- STD-202, Method 208
- Polarity: Color band denotes cathode end



Limiting Values (Absolute Maximum Rating)

Item	Symbol	Unit	Test Conditions	DSS 12	DSS 13	DSS 14	DSS 15	DSS 16	DSS 18	DSS 110	DSS 115	DSS 120
Repetitive Peak Reverse Voltage	V _{RRM}	V		20	30	40	50	60	80	100	150	200
Maximum RMS Voltage	V _{RMS}	V		14	21	28	35	42	56	70	105	140
Maximum DC Blocking Voltage	V _{DC}	V		20	30	40	50	60	80	100	150	200
Average Forward Current	I _{F(AV)}	A	60HZ Half-sine wave, Resistance load, TL(Fig.1)	1.0								
Surge(Non-repetitive)Forward Current	I _{FSM}	A	60Hz Half-sine wave ,1 cycle , Ta =25℃	30								
Junction Temperature	T _J	℃		-55~+125			-55~+150					
Storage Temperature	T _{STG}	℃		-55 ~ +150								

Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

Item	Symbol	Unit	Test Condition		DSS 12	DSS 13	DSS 14	DSS 15	DSS 16	DSS 18	DSS 110	DSS 115	DSS 120
Peak Forward Voltage	V _F	V	I _F =1.0A		0.55			0.70		0.85		0.95	
Peak Reverse Current	I _{RRM1}	mA	V _{RM} =V _{RRM}	T _a =25℃	0.5					0.1			
	T _a =100℃			10					5.0				
Thermal Resistance(Typical)	R _{θJ-A}	℃/W	Between junction and ambient		85								
	Between junction and terminal		23										
	Between junction and case		15										
Juction Capacitance (Typical)	Cj	pF	Measured at 1.0MHz and applied reverse voltage of 4.0 volts.		42			33		32		17	

Typical Characteristics

FIG.1: FORWARD CURRENT DERATING CURVE

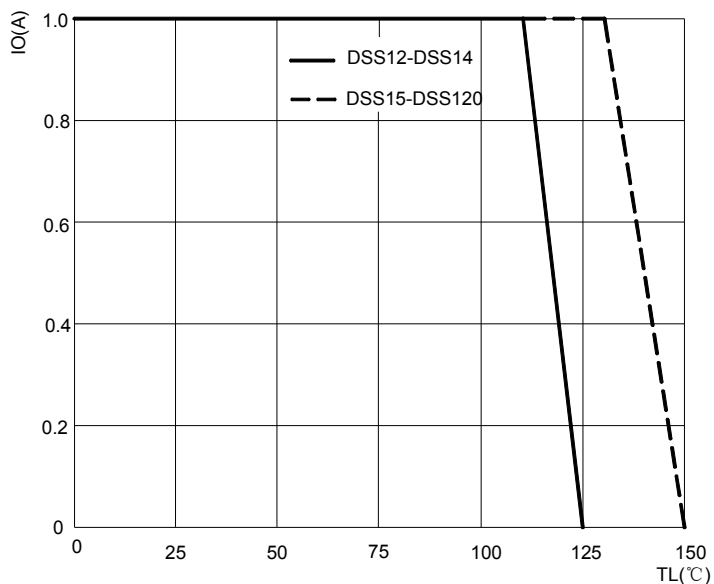


FIG2: Surge Forward Current Capability

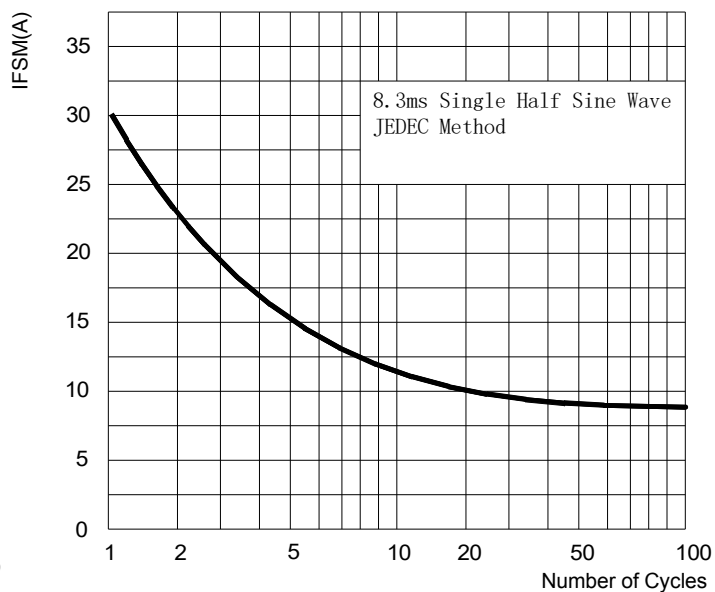


FIG.3: TYPICAL FORWARD CHARACTERISTICS

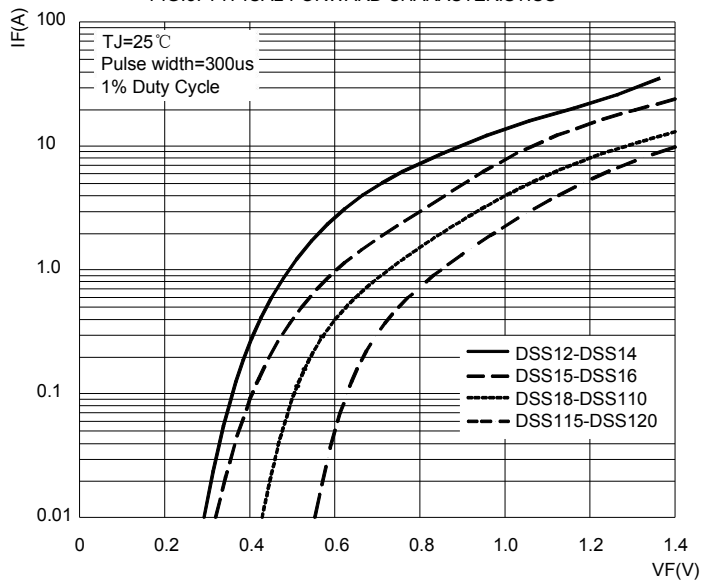
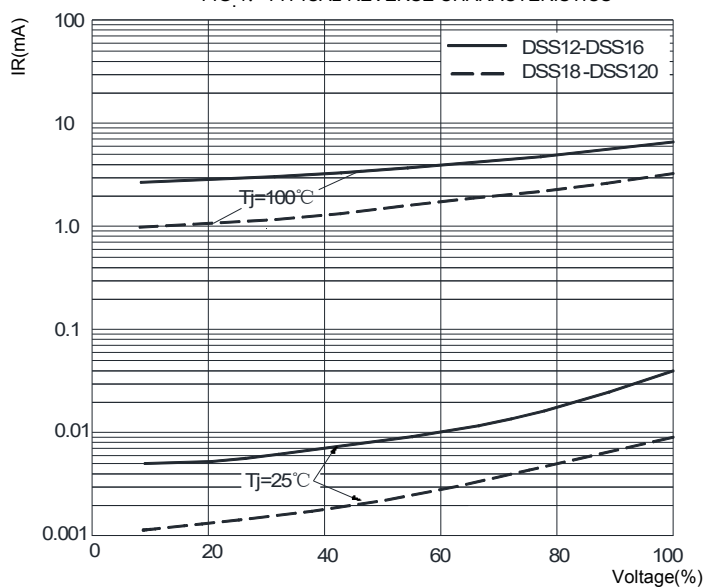
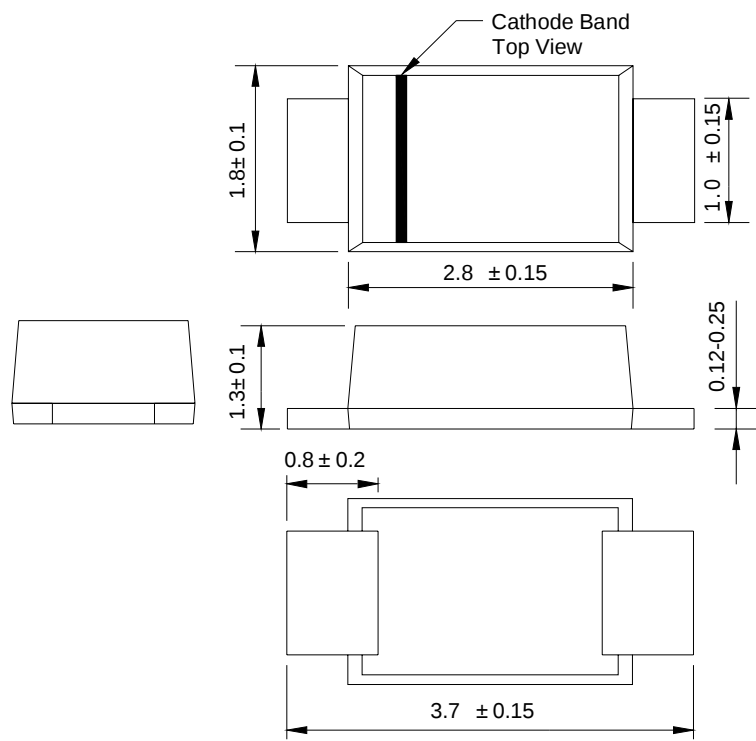


FIG.4: TYPICAL REVERSE CHARACTERISTICS

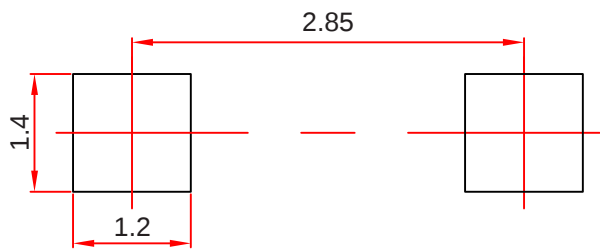


SOD-123FL Package Outline Dimensions



Dimensions in millimeters

SOD-123FL Suggested Pad Layout



- Note:**
- 1. Controlling dimension: in millimeters.
 - 2. General tolerance: ± 0.05mm.
 - 3. The pad layout is for reference purposes only.

Ordering Information

Part Number	Package	Shipping Quantity
DSS12-DSS120	SOD-123FL	3000/tape&Reel

Marking Diagram



X: From 2 To 20

Reel Taping Specifications For Surface Mount Devices–SOD-123FL

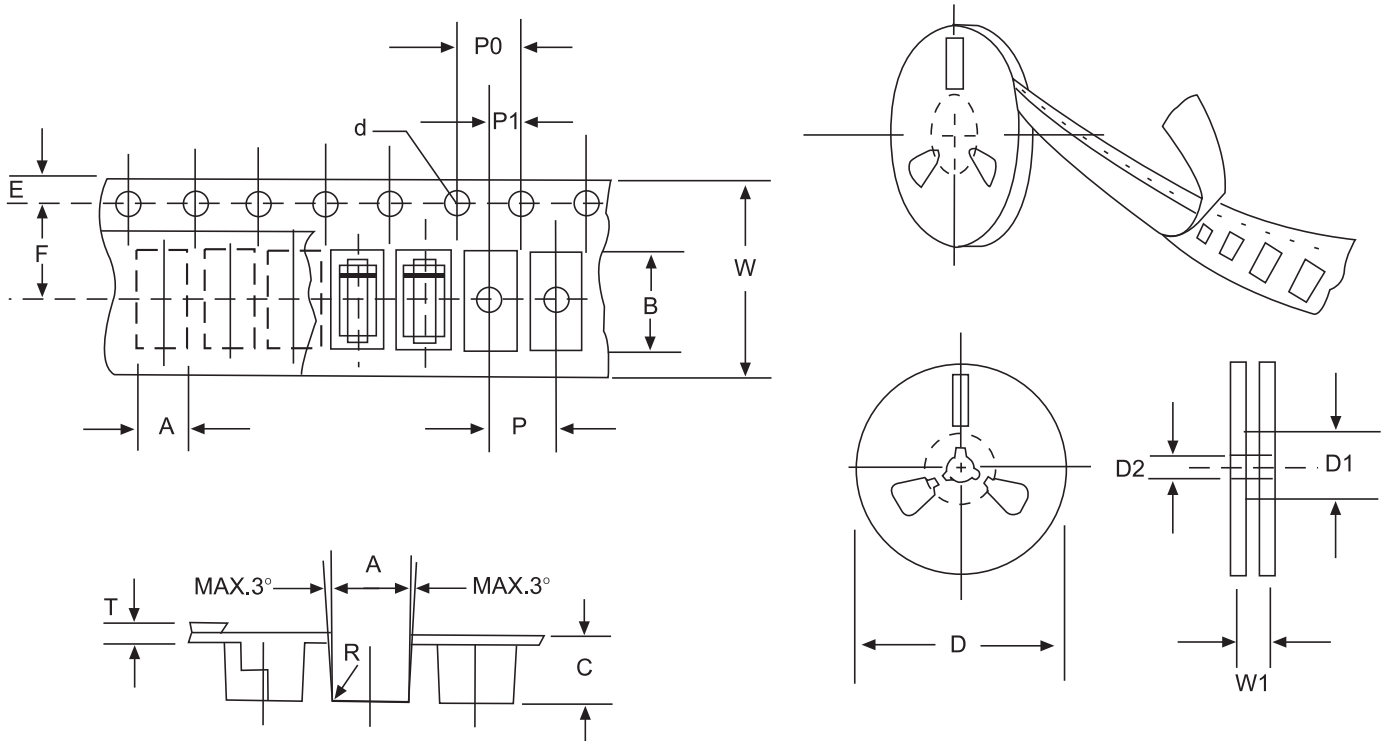


FIG: CONFIGURATION OF SURFACE MOUNTED DEVICES TAPING

ITEM	SYMBOL	SOD-123FLmm(inch)
Carrier width	A	2.05±0.1(0.081±0.004)
Carrier length	B	3.95±0.1(0.156±0.004)
Carrier depth	C	1.45±0.1(0.057±0.004)
Sprocket hole	d	1.55±0.05(0.061±0.002)
Reel outside diameter	D	178±2.0(7.0±0.079)
Reel inner diameter	D1	54±1.0(2.13±0.039)
Feed hole diameter	D2	13±0.5(0.512±0.020)
Sprocket hole position	E	1.75±0.1(0.069±0.004)
Punch hole position	F	3.50±0.1(0.138±0.002)
Punch hole pitch	P	4.0±0.1(0.157±0.004)
Sprocket hole pitch	P0	4.0±0.1(0.157±0.004)
Embossment center	P1	2.0±0.1(0.079±0.004)
Total tape thickness	T	0.21±0.25(0.008±0.010)
Tape width	W	8.0±0.2(0.315±0.008)
Reel width	W1	10.0±2.0(0.394±0.079)

NOTE: Devices are packed in accordance with EIA standard RS-481-A and specification given above.